

This document includes the programming specifications for the following devices:

- PIC12C671
- PIC12C672
- PIC12CE673
- PIC12CE674

1.0 PROGRAMMING THE PIC12C67X AND PIC12CE67X

The PIC12C67X and PIC12CE67X can be programmed using a serial method. In serial mode the PIC12C67X and PIC12CE67X can be programmed while in the users system. This allows for increased design flexibility.

1.1 <u>Hardware Requirements</u>

The PIC12C67X and PIC12CE67X requires two programmable power supplies, one for VDD (2.0V to 6.0V recommended) and one for VPP (12V to 14V). Both supplies should have a minimum resolution of 0.25V.

1.2 Programming Mode

The programming mode for the PIC12C67X and PIC12CE67X allows programming of user program memory, special locations used for ID, and the configuration word for the PIC12C67X and PIC12CE67X.



PIN DESCRIPTIONS (DURING PROGRAMMING): PIC12C671/672 and PIC12CE673/674

	During Programming							
Pin Name	Pin Name	Pin Type	Pin Description					
GP1	CLOCK	I	Clock input					
GP0	DATA	I/O	Data input/output					
GP3/MCLR/Vpp	Vpp	Р	Programming Power					
Vdd	Vdd	Р	Power Supply					
Vss	Vss	Р	Ground					

Legend: I = Input, O = Output, P = Power

© 1998 Microchip Technology Inc.

2.0 PROGRAM MODE ENTRY

2.1 User Program Memory Map

The user memory space extends from 0x0000 to 0x1FFF (8K). Table 2-1 shows actual implementation of program memory in the PIC12C67X family.

TABLE 2-1:IMPLEMENTATION OF
PROGRAM MEMORY IN THE
PIC12C67X

Device	Program Memory Size
PIC12C671/ PIC12CE673	0x000 - 0x3FF (1K)
PIC12C672/ PIC12CE674	0x000 - 0x7FF (2K)

When the PC reaches the last location of the implemented program memory, it will wrap around and address a location within the physically implemented memory (see Figure 2-1).

In programming mode the program memory space extends from 0x0000 to 0x3FFF, with the first half (0x0000-0x1FFF) being user program memory and the second half (0x2000-0x3FFF) being configuration memory. The PC will increment from 0x0000 to 0x1FFF and wrap to 0x000 or 0x2000 to 0x3FFF and wrap around to 0x2000 (not to 0x0000). Once in configuration memory, the highest bit of the PC stays a '1', thus always pointing to the configuration memory. The only way to point to user program memory is to reset the part and reenter program/verify mode, as described in Section 2.2.

The last location of the program memory space holds the factory programmed oscillator calibration value. This location should not be programmed except when blank (a non-blank value should not cause the device to fail a blank check). If blank, the programmer should program it to a RETLW XX statement where "XX" is the calibration value. In the configuration memory space, 0x2000-0x20FF are utilized. When in configuration memory, as in the user memory, the 0x2000-0x2XFF segment is repeatedly accessed as the PC exceeds 0x2XFF (see Figure 2-1).

A user may store identification information (ID) in four ID locations. The ID locations are mapped in [0x2000 : 0x2003].

- Note 1: All other locations in PIC configuration memory are reserved and should not be programmed.
- Note 2: Due to the secure nature of the on-board EEPROM memory in the PIC12CE673/674, it can be accessed only by the user program.

DS40175A-page 2

FIGURE 2-1: PROGRAM MEMORY MAPPING



^{© 1998} Microchip Technology Inc.

2.2 Program/Verify Mode

The program/verify mode is entered by holding pins GP1 and GP0 low while raising MCLR pin from VIL to VIHH (high voltage). VDD is then raised from VIL to VIH.Once in this mode the user program memory and the configuration memory can be accessed and programmed in serial fashion. The mode of operation is serial, and the memory that is accessed is the user program memory. GP1 is a Schmitt Trigger input in this mode.

The sequence that enters the device into the programming/verify mode places all other logic into the reset state (the $\overline{\text{MCLR}}$ pin was initially at VIL). This means that all I/O are in the reset state (High impedance inputs).

- Note 1: The MCLR pin must be raised from VIL to VIHH before VDD is applied. This is to ensure that the device does not have the PC incremented while in valid operation range.
- Note 2: Do not power GP2, GP4 or GP5 before VDD is applied.

1.0.1 PROGRAM/VERIFY OPERATION

The GP1 pin is used as a clock input pin, and the GP0 pin is used for entering command bits and data input/output during serial operation. To input a command, the clock pin (GP1) is cycled six times. Each command bit is latched on the falling edge of the clock with the least significant bit (LSB) of the command being input first. The data on pin GP0 is required to have a minimum setup and hold time (see AC/DC specs) with respect to the falling edge of the clock. Commands that have data associated with them (read and load) are specified to have a minimum delay of 1µs between the command and the data. After this delay the clock pin is cycled 16 times with the first cycle being a start bit and the last cycle being a stop bit. Data is also input and output LSB first. Therefore, during a read operation the LSB will be transmitted onto pin GP0 on the rising edge of the second cycle, and during a load operation the LSB will be latched on the falling edge of the second cycle. A minimum 1µs delay is also specified between consecutive commands.

All commands are transmitted LSB first. Data words are also transmitted LSB first. The data is transmitted on the rising edge and latched on the falling edge of the clock. To allow for decoding of commands and reversal of data pin configuration, a time separation of at least 1µs is required between a command and a data word (or another command).

The commands that are available are listed in Table 1-1.

1.0.1.1 LOAD CONFIGURATION

After receiving this command, the program counter (PC) will be set to 0x2000. By then applying 16 cycles to the clock pin, the chip will load 14-bits a "data word" as described above, to be programmed into the configuration memory. A description of the memory mapping schemes for normal operation and configuration mode

operation is shown in Figure 2-1. After the configuration memory is entered, the only way to get back to the user program memory is to exit the program/verify test mode by taking MCLR low (VIL).

Command		Мар	ping (N	/ISB	Data		
Load Configuration	0	0	0	0	0	0	0, data(14), 0
Load Data	0	0	0	0	1	0	0, data(14), 0
Read Data	0	0	0	1	0	0	0, data(14), 0
Increment Address	0	0	0	1	1	0	
Begin programming	0	0	1	0	0	0	
End Programming	0	0	1	1	1	0	

TABLE 1-1:COMMAND MAPPING



FIGURE 1-1: PROGRAM FLOW CHART - PIC12C67X AND PIC12CE67X PROGRAM MEMORY

© 1998 Microchip Technology Inc.

FIGURE 1-2: PROGRAM FLOW CHART - PIC12C67X AND PIC12CE67X CONFIGURATION WORD & ID LOCATIONS



DS40175A-page 6

1.0.1.2 LOAD DATA

After receiving this command, the chip will load in a 14-bit "data word" when 16 cycles are applied, as described previously. A timing diagram for the load data command is shown in Figure 4-1.

1.0.1.3 READ DATA

After receiving this command, the chip will transmit data bits out of the memory currently accessed starting with the second rising edge of the clock input. The GP0 pin will go into output mode on the second rising clock edge, and it will revert back to input mode (hi-impedance) after the 16th rising edge. A timing diagram of this command is shown in Figure 4-2.

1.0.1.4 INCREMENT ADDRESS

The PC is incremented when this command is received. A timing diagram of this command is shown in Figure 4-3.

1.0.1.5 BEGIN PROGRAMMING

A load command (load configuration or load data) must be given before every begin programming command. Programming of the appropriate memory (test program memory or user program memory) will begin after this command is received and decoded. Programming should be performed with a series of 100µs programming pulses. A programming pulse is defined as the time between the begin programming command and the end programming command.

1.0.1.6 END PROGRAMMING

After receiving this command, the chip stops programming the memory (configuration program memory or user program memory) that it was programming at the time.

1.1 <u>Programming Algorithm Requires</u> <u>Variable VDD</u>

The PIC12C67X and PIC12CE67X uses an intelligent algorithm. The algorithm calls for program verification at VDDmin as well as VDDmax. Verification at VDDmin guarantees good "erase margin". Verification at VDDmax guarantees good "program margin".

The actual programming must be done with VDD in the VDDP range (4.75 - 5.25V).

VDDP = VCC range required during programming.

VDD min. = minimum operating VDD spec for the part.

VDD max.= maximum operating VDD spec for the part.

Programmers must verify the PIC12C67X and PIC12CE67X at its specified VDDmax and VDDmin levels. Since Microchip may introduce future versions of the PIC12C67X and PIC12CE67X with a broader VDD range, it is best that these levels are user selectable (defaults are ok).

Note: Any programmer not meeting these requirements may only be classified as "prototype" or "development" programmer but not a "production" quality programmer.

^{© 1998} Microchip Technology Inc.

2.0 CONFIGURATION WORD

The PIC12C67X and PIC12CE67X family members have several configuration bits. These bits can be programmed (reads '0') or left unprogrammed (reads '1') to select various device configurations. Figure 2-1 provides an overview of configuration bits.

FIGURE 2-1: CONFIGURATION WORD

Bit N	umbe	er:													
13	12	11	10	9	8	7	6	5	4	3	2	1	0		
CP1	CP0	CP1	CP0	CP1	CP0	MCLRE	CP1	CP0	PWRTE	WDTE	FOSC2	FOSC1	FOSC0	Register: Address	CONFIG 2007h
bit 1: bit 7:	3-8, 6	-5: C 1 1 0 0 MCI	CP1:Cl 1 = Cd 0 = 04 1 = 02 0 = 00 LRE: (= GP	P0: Co ode pi 100h-(200h-(200h-(3P3/N 3/MC	ode Protecti 07FFh 07FFh 07FFh 07FFh MCLR LR pir	rotection I on off code pro code pro code pro pin function	bits (1 tected tected tected on sel is MC) (2) l; l; l; ect LR							
bit 4:		0 PW 1 0	= GP RTE: I = PW = PW	3/MC Power /RT di /RT ei	LR pir ⁻ -up Ti sableo nableo	n function mer Enat d	is digi Ie bit	tal I/O (1)	, MCLR int	ernally tie	ed to Vdd				
bit 3:		WD.	TE: W	atchd	og Tin	ner Enabl	e bit								
		1 0	= WD = WD)T ena)T disa	abled abled										
bit 2-	0:	FOS	SC2:F	osco): Osc	illator Sel	ection	bits							
		1 1 1 0 0 0 0	$ \begin{array}{r} 11 = E \\ 10 = E \\ 01 = I \\ 00 = I \\ 11 = ii \\ 10 = F \\ 01 = 2 \\ 00 = L \end{array} $	EXTRO EXTRO NTRO NTRO NTRO IS os (T oso P oso	C osci C osci C oscil C oscil S oscil S oscil S oscil S oscil S oscil C oscillator C oscillator	llator / CL llator / GF lator / CL lator / GP tion r	KOU ⁻ 24 fun 4 func	funct ction c functi tion o	ion on GP4 on GP4/OS on on GP4, n GP4/OSC	4/OSC2/C C2/CLKC /OSC2/C C2/CLKO	CLKOUT p DUT pin LKOUT pi UT pin	in n			
No	ote 3:	All	of the	CP1:	CP0 p	oairs have	to be	given	the same	value to e	enable the	code prot	tection sch	neme listed.	
	4	: 07l cor	FFh is ntains	alwa the R	ys und ETLW	odeprote / xx calibr	cted o ation	n the nstruc	12C672 and tion for the	d 03FFh i INTRC.	s always i	uncodepro	otected on	the 12C671	. This location

3.0 CODE PROTECTION

The program code written into the EPROM can be protected by writing to the CP0 & CP1 bits of the configuration word. For PIC12C67X and PIC12CE67X devices, once code protection is enabled, all protected segments read '0's (or "garbage values") and are prevented from further programming. All unprotected segments, including ID and configuration word locations, and calibration word location read normally and can be programmed.

3.1 Embedding Configuration Word and ID Information in the Hex File

To allow portability of code, the programmer is required to read the configuration word and ID locations from the hex file when loading the hex file. If configuration word information was not present in the hex file then a simple warning message may be issued. Similarly, while saving a hex file, configuration word and ID information must be included. An option to not include this information may be provided.

Microchip Technology Inc. feels strongly that this feature is important for the benefit of the end customer.

TABLE 3-1: CONFIGURATION WORD

PIC12C671, PIC12CE673

To code protect:

٠	Protect all memory	00	0000	X00X	XXXX
٠	Protect 0200h-07FFh	01	0101	X01X	XXXX
	No oodo mustaatian			*** ***	

 No code protection 	11	1111	X11X	XXXX
 No code protection 	11	1111	X11X	XXX

Program Memory Segment	R/W in Protected Mode	R/W in Unprotected Mode
Configuration Word (0x2007)	Read Unscrambled, Write Enabled	Read Unscrambled, Write Enabled
Unprotected memory segment	Read Unscrambled, Write Enabled	Read Unscrambled, Write Enabled
Protected memory segment	Read All 0's, Write Disabled	Read Unscrambled, Write Enabled
ID Locations (0x2000 : 0x2003)	Read Unscrambled, Write Enabled	Read Unscrambled, Write Enabled
INTRC Calibration Word (0X3FF)	Read Unscrambled, Write Enabled	Read Unscrambled, Write Enabled

PIC12C672, PIC12CE674

To code protect:

 Protect all memory 	00	0000	x00x	XXXX
 Protect 0200h-07FFh 	01	0101	X01X	XXXX
 Protect 0400h-07FFh 	10	1010	X10X	XXXX
 No code protection 	11	1111	X11X	XXXX

Program Memory Segment	R/W in Protected Mode	R/W in Unprotected Mode
Configuration Word (0x2007)	Read Unscrambled, Write Enabled	Read Unscrambled, Write Enabled
Unprotected memory segment	Read Unscrambled, Write Enabled	Read Unscrambled, Write Enabled
Protected memory segment	Read All 0's, Write Disabled	Read Unscrambled, Write Enabled
ID Locations (0x2000 : 0x2003)	Read Unscrambled, Write Enabled	Read Unscrambled, Write Enabled
INTRC Calibration Word (0X7FF)	Read Unscrambled, Write Enabled	Read Unscrambled, Write Enabled

3.2 <u>Checksum</u>

3.2.1 CHECKSUM CALCULATIONS

Checksum is calculated by reading the contents of the PIC12C67X and PIC12CE67X memory locations and adding the opcodes up to the maximum user addressable location, excluding the oscillator calibration location in the last address, e.g., 0x3FE for the PIC12C671/CE673. Any carry bits exceeding 16-bits are neglected. Finally, the configuration word (appropriately masked) is added to the checksum. Checksum computation for each member of the PIC12C67X and PIC12CE67X devices is shown in Table 3-2.

The checksum is calculated by summing the following:

- The contents of all program memory locations
- The configuration word, appropriately masked
- Masked ID locations (when applicable)

The least significant 16 bits of this sum is the checksum.

The following table describes how to calculate the checksum for each device. Note that the checksum calculation differs depending on the code protect setting. Since the program memory locations read out differently depending on the code protect setting, the table describes how to manipulate the actual program memory values to simulate the values that would be read from a protected device. When calculating a checksum by reading a device, the entire program memory can simply be read and summed. The configuration word and ID locations can always be read.

Note that some older devices have an additional value added in the checksum. This is to maintain compatibility with older device programmer checksums.

Device	Code Protect	Checksum*	Blank Value	Ox25E6 at 0 and max address
PIC12C671	OFF	SUM[0x000:0x3FE] + CFGW & 0x3FFF	3B3F	070D
PIC12CE673	1/2	SUM[0x000:0x1FF] + CFGW & 0x3FFF + SUM_ID	4E5E	0013
	ALL	CFGW & 0x3FFF + SUM_ID	3B4E	071C
PIC12C672	OFF	SUM[0x000:0x7FE] + CFGW & 0x3FFF	373F	030D
PIC12CE674	1/2	SUM[0x000:0x3FF] + CFGW & 0x3FFF + SUM_ID	5D6E	0F23
	3/4	SUM[0x000:0x1FF] + CFGW & 0x3FFF + SUM_ID	4A5E	FC13
	ALL	CFGW & 0x3FFF + SUM_ID	374E	031C

TABLE 3-2: CHECKSUM COMPUTATION

Legend: CFGW = Configuration Word

SUM[a:b] = [Sum of locations a through b inclusive]

SUM_ID = ID locations masked by 0xF then made into a 16-bit value with ID0 as the most significant nibble.

For example,

ID0 = 0x12, ID1 = 0x37, ID2 = 0x4, ID3 = 0x26, then SUM_ID = 0x2746.

*Checksum = [Sum of all the individual expressions] MODULO [0xFFFF]

+ = Addition

& = Bitwise AND

4.0 PROGRAM/VERIFY MODE ELECTRICAL CHARACTERISTICS

TABLE 4-1:AC/DC CHARACTERISTICSTIMING REQUIREMENTS FOR PROGRAM/VERIFY TEST MODE

Standard Operating Conditions

Operating Temperature: $+10^{\circ}C \le TA \le +40^{\circ}C$, unless otherwise stated, (25°C is recommended)Operating Voltage: $4.5V \le VDD \le 5.5V$, unless otherwise stated.

		·					.
Parameter No.	Sym.	Characteristic	Min.	Тур.	Max.	Units	Conditions
General							
PD1	Vddp	Supply voltage during programming	4.75	5.0	5.25	V	
PD2	IDDP	Supply current (from VDD) during programming			20	mA	
PD3	Vddv	Supply voltage during verify	Vddmin		VDDmax	V	Note 1
PD4	VIHH1	Voltage on MCLR/VPP during programming	12.75		13.25	V	Note 2
PD5	VIHH2	Voltage on MCLR/VPP during verify	VDD + 4.0		13.5		
PD6	IPP	Programming supply current (from VPP)			50	mA	
PD9	ViH1	(GP0, GP1) input high level	0.8 Vdd			V	Schmitt Trigger input
PD8	VIL1	(GP0, GP1) input low level	0.2 Vdd			V	Schmitt Trigger input

Serial Program Verify										
P1	TR	MCLR/VPP rise time (VSS to VIHH) for test mode entry			8.0	μs				
P2	Tf	MCLR Fall time			8.0	μs				
P3	Tset1	Data in setup time before clock \downarrow	100			ns				
P4	Thld1	Data in hold time after clock \downarrow	100			ns				
P5	Tdly1	Data input not driven to next clock input (delay required between com- mand/data or command/command)	1.0			μs				
P6	Tdly2	Delay between clock \downarrow to clock \uparrow of next command or data	1.0			μs				
P7	Tdly3	Clock ↑ to data out valid (during read data)	200			ns				
P8	Thld0	Hold time after VDD↑	2			μs				
P9	TPPDP	Hold time after VPP↑	5			μs				

Note 1: Program must be verified at the minimum and maximum VDD limits for the part.

Note 2: VIHH must be greater than VDD + 4.5V to stay in programming/verify mode.











^{© 1998} Microchip Technology Inc.

NOTES:

^{© 1998} Microchip Technology Inc.



WORLDWIDE SALES AND SERVICE

AMERICAS

Corporate Office

Microchip Technology Inc. 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 602-786-7200 Fax: 602-786-7277 *Technical Support:* 602 786-7627 *Web:* http://www.microchip.com

Atlanta

Microchip Technology Inc. 500 Sugar Mill Road, Suite 200B Atlanta, GA 30350 Tel: 770-640-0034 Fax: 770-640-0307

Boston

Microchip Technology Inc. 5 Mount Royal Avenue Marlborough, MA 01752 Tel: 508-480-9990 Fax: 508-480-8575

Chicago

Microchip Technology Inc. 333 Pierce Road, Suite 180 Itasca, IL 60143 Tel: 630-285-0071 Fax: 630-285-0075

Dallas

Microchip Technology Inc. 14651 Dallas Parkway, Suite 816 Dallas, TX 75240-8809 Tel: 972-991-7177 Fax: 972-991-8588

Dayton

Microchip Technology Inc. Two Prestige Place, Suite 150 Miamisburg, OH 45342 Tel: 937-291-1654 Fax: 937-291-9175

Los Angeles

Microchip Technology Inc. 18201 Von Karman, Suite 1090 Irvine, CA 92612 Tel: 714-263-1888 Fax: 714-263-1338

New York

Microchip Technology Inc. 150 Motor Parkway, Suite 202 Hauppauge, NY 11788 Tel: 516-273-5305 Fax: 516-273-5335

San Jose

Microchip Technology Inc. 2107 North First Street, Suite 590 San Jose, CA 95131 Tel: 408-436-7950 Fax: 408-436-7955

Toronto

Microchip Technology Inc. 5925 Airport Road, Suite 200 Mississauga, Ontario L4V 1W1, Canada Tel: 905-405-6279 Fax: 905-405-6253

ASIA/PACIFIC

Hong Kong

Microchip Asia Pacific RM 3801B, Tower Two Metroplaza 223 Hing Fong Road Kwai Fong, N.T., Hong Kong Tel: 852-2-401-1200 Fax: 852-2-401-3431

India

Microchip Technology Inc. India Liaison Office No. 6, Legacy, Convent Road Bangalore 560 025, India Tel: 91-80-229-0061 Fax: 91-80-229-0062

Japan

Microchip Technology Intl. Inc. Benex S-1 6F 3-18-20, Shinyokohama Kohoku-Ku, Yokohama-shi Kanagawa 222 Japan Tel: 81-45-471- 6166 Fax: 81-45-471-6122

Korea

Microchip Technology Korea 168-1, Youngbo Bldg. 3 Floor Samsung-Dong, Kangnam-Ku Seoul, Korea Tel: 82-2-554-7200 Fax: 82-2-558-5934

Shanghai

Microchip Technology RM 406 Shanghai Golden Bridge Bldg. 2077 Yan'an Road West, Hong Qiao District Shanghai, PRC 200335 Tel: 86-21-6275-5700 Fax: 86 21-6275-5060

Singapore

Microchip Technology Taiwan Singapore Branch 200 Middle Road #07-02 Prime Centre Singapore 188980 Tel: 65-334-8870 Fax: 65-334-8850

ASIA/PACIFIC (CONTINUED)

Taiwan, R.O.C Microchip Technology Taiwan 10F-1C 207 Tung Hua North Road Taipei, Taiwan, ROC Tel: 886-2-2717-7175 Fax: 886-2-2545-0139

EUROPE

United Kingdom

Arizona Microchip Technology Ltd. 505 Eskdale Road Winnersh Triangle Wokingham Berkshire, England RG41 5TU Tel: 44-1189-21-5858 Fax: 44-1189-21-5835

France

Arizona Microchip Technology SARL Zone Industrielle de la Bonde 2 Rue du Buisson aux Fraises 91300 Massy, France Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

Germany

Arizona Microchip Technology GmbH Gustav-Heinemann-Ring 125 D-81739 Müchen, Germany Tel: 49-89-627-144 0 Fax: 49-89-627-144-44

Italy

Arizona Microchip Technology SRL Centro Direzionale Colleoni Palazzo Taurus 1 V. Le Colleoni 1 20041 Agrate Brianza Milan, Italy Tel: 39-39-6899939 Fax: 39-39-6899883

1/13/98



Microchip received ISO 9001 Quality System certification for its worldwide headquarters, design, and wafer fabrication facilities in January, 1997. Our field-programmable PICmicro™ 8-bit MCUs, Serial EEPROMs, related specialty memory products and development systems conform to the stringent quality standards of the International Standard Organization (ISO).

All rights reserved. © 1998, Microchip Technology Incorporated, USA. 2/98 💭 Printed on recycled paper.

Information contained in this publication regarding device applications and the like is intended for suggestion only and may be superseded by updates. No representation or warranty is given and no liability is assumed by Microchip Technology Incorporated with respect to the accuracy or use of such information, or infringement of patents or other intellectual property rights arising from such use or otherwise. Use of Microchip's products as critical components in life support systems is not authorized except with express written approval by Microchip. No licenses are conveyed, implicitly or otherwise, under any intellectual property rights. The Microchip logo and name are registered trademarks of Microchip Technology Inc. in the U.S.A. and other countries. All rights reserved. All other trademarks mentioned herein are the property of their respective companies.

Downloaded from Elcodis.com electronic components distributor